

CMPD7000E

**ENHANCED SPECIFICATION  
SURFACE MOUNT  
DUAL, IN SERIES  
SILICON SWITCHING DIODES**



www.centrasemi.com

**DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CMPD7000E is an Enhanced version of the CMPD7000 Dual, Series Configuration, Ultra-High Speed Switching Diode. This device is manufactured by the epitaxial planar process, in an epoxy molded surface mount SOT-23 package, designed for high speed switching applications.

**MARKING CODE: C5CE**

**FEATURED ENHANCED SPECIFICATIONS:**

- ◆  $BV_R$  from 100V min to 120V min.
- ◆  $V_F$  from 1.1V max to 1.0V max.



**MAXIMUM RATINGS:** ( $T_A=25^\circ\text{C}$ )

- ◆ **Peak Repetitive Reverse Voltage**
- Average Forward Current
- Peak Forward Current
- Power Dissipation
- Operating and Storage Junction Temperature
- Thermal Resistance

SYMBOL		UNITS
$V_{RRM}$	120	V
$I_O$	200	mA
$I_{FM}$	500	mA
$P_D$	350	mW
$T_J, T_{stg}$	-65 to +150	$^\circ\text{C}$
$\theta_{JA}$	357	$^\circ\text{C/W}$

**ELECTRICAL CHARACTERISTICS PER DIODE:** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
$I_R$	$V_R=50\text{V}$			300	nA
$I_R$	$V_R=50\text{V}, T_A=125^\circ\text{C}$			100	$\mu\text{A}$
$I_R$	$V_R=100\text{V}$			500	nA
◆ $BV_R$	$I_R=100\mu\text{A}$	120	150		V
◆ $V_F$	$I_F=1.0\text{mA}$	0.55	0.59	0.65	V
◆ $V_F$	$I_F=10\text{mA}$	0.67	0.72	0.77	V
◆ $V_F$	$I_F=100\text{mA}$	0.85	0.91	1.0	V
$C_T$	$V_R=0, f=1.0\text{MHz}$		1.5	2.6	pF
$t_{rr}$	$I_R=I_F=10\text{mA}, R_L=100\Omega, \text{Rec. to } 1.0\text{mA}$		2.0	4.0	ns

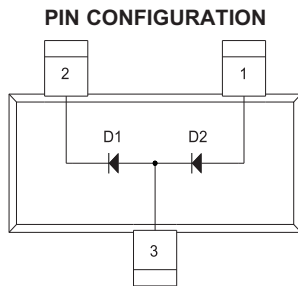
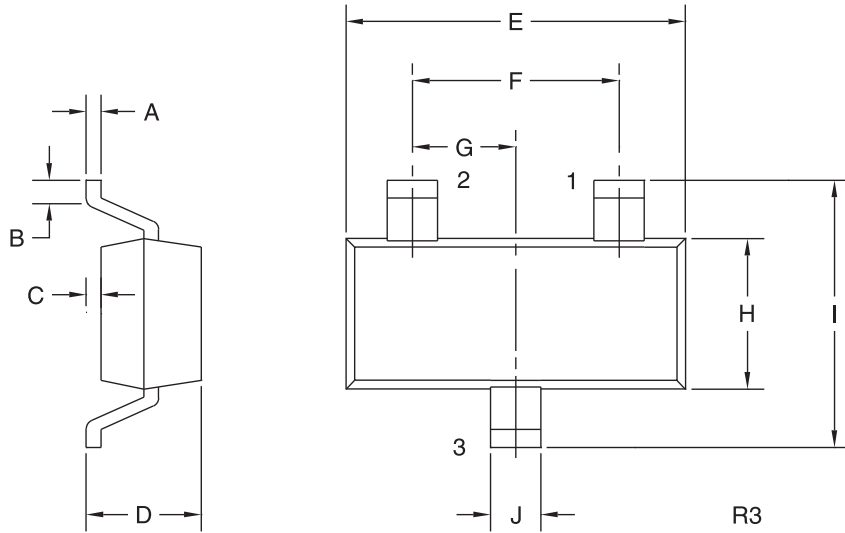
◆ Enhanced Specification

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**SOT-23 CASE - MECHANICAL OUTLINE**



**LEAD CODE:**

- 1) Anode D2
- 2) Cathode D1
- 3) Anode D1, Cathode D2

**MARKING CODE: C5CE**

<b>DIMENSIONS</b>				
SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.003	0.007	0.08	0.18
B	0.006	-	0.15	-
C	-	0.005	-	0.13
D	0.035	0.043	0.89	1.09
E	0.110	0.120	2.80	3.05
F	0.075		1.90	
G	0.037		0.95	
H	0.047	0.055	1.19	1.40
I	0.083	0.098	2.10	2.49
J	0.014	0.020	0.35	0.50

SOT-23 (REV: R3)

R4 (27-January 2010)

## OUTSTANDING SUPPORT AND SUPERIOR SERVICES



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### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

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### DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

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### REQUESTING PRODUCT PLATING

1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

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### CONTACT US

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